

AC Thyristor Triac power switch Rev. 1 — 1 November 2011

Product data sheet

Product profile 1.

1.1 General description

AC Thyristor Triac power switch in a SOT226A (I2PAK) plastic package with self-protective clamping capabilities against low and high energy transients.

1.2 Features and benefits

- Clamping structure ensuring safe high over-voltage withstand capability
- Direct interfacing with low power drivers and microcontrollers
- Full cycle AC conduction
- Over-voltage withstand capability to IEC 61000-4-5
- Pin compatible with standard triacs
- Planar passivated for voltage ruggedness and reliability

1.3 Applications

- AC Fan controllers
- Highly inductive, resistive and safety loads
- Large and small appliances (White Goods)
- Loads such as contactors, circuit breakers, valves, dispensers and door locks
- Pump motor circuits
- Reversing induction motor control

- Protective self turn-on capability for high energy transients
- Safe clamping capability for low energy over-voltage transients
- Sensitive gate for easy logic level triggering
- Triggering in three quadrants only
- Very high immunity to false turn-on by dV/dt



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1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	-	800	V
I _{TSM}	non-repetitive peak on-state current	full sine wave; T _{j(init)} = 25 °C; t _p = 20 ms; see <u>Figure 5</u> ; see <u>Figure 6</u>	-	-	51	А
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 108 °C; see <u>Figure 1</u> ; see <u>Figure 2;</u> see <u>Figure 4</u>	-	-	6	A
V _{CL}	clamping voltage	I _{CL} = 0.1 mA; t _p = 1 ms; T _j = 25 °C	850	-	-	V
V _{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; see <u>Figure 3</u>	-	-	2	kV
						-

2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	СМ	common		10
2	LD	load		
3	G	gate	0	G
mb	LD	mounting base; load		 CM 003aaf29€

3. Ordering information

Table 3.Ordering information

Type number	Package		
	Name	Description	Version
ACTT6G-800E	I2PAK	plastic single-ended package (I2PAK); TO-262	SOT226A

SOT226A (I2PAK)

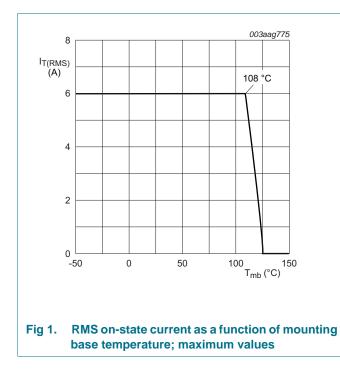
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4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{DRM}	repetitive peak off-state voltage		-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{mb} ≤ 108 °C; see <u>Figure 1</u> ; see Figure 2; see Figure 4	-	6	A
I _{TSM}	non-repetitive peak on-state	full sine wave; T _{j(init)} = 25 °C; t _p = 16.7 ms	-	56	А
	current	full sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 20 \text{ ms}$; see <u>Figure 5</u> ; see <u>Figure 6</u>	-	51	A
l ² t	l ² t for fusing	t _p = 10 ms; sine-wave pulse	-	13	A ² s
dl _T /dt	rate of rise of on-state current	$I_T = 9 \text{ A}; I_G = 0.2 \text{ A}; dI_G/dt = 0.2 \text{ A}/\mu\text{s}$	-	100	A/µs
I _{GM}	peak gate current	t = 20 μs	-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C
V _{PP}	peak pulse voltage	T _j = 25 °C; non-repetitive, off-state; see <u>Figure 3</u>	-	2	kV



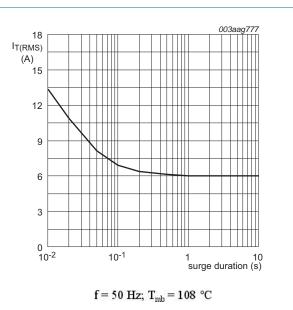
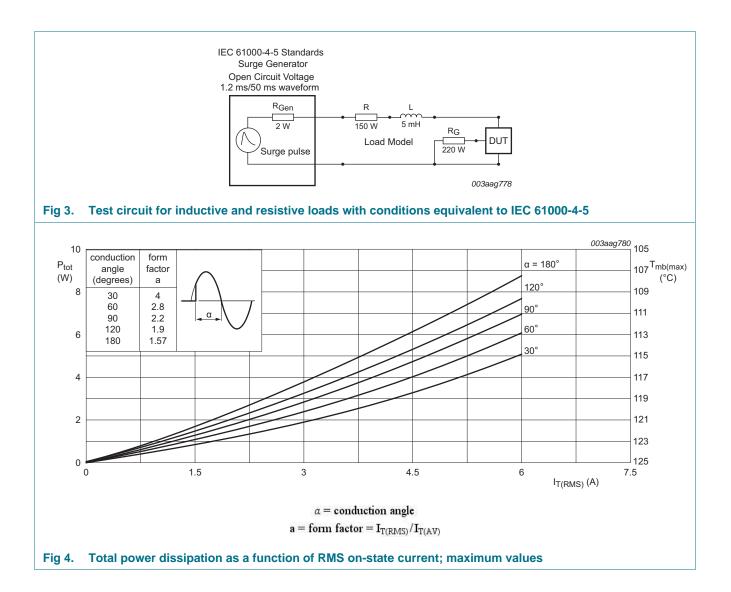


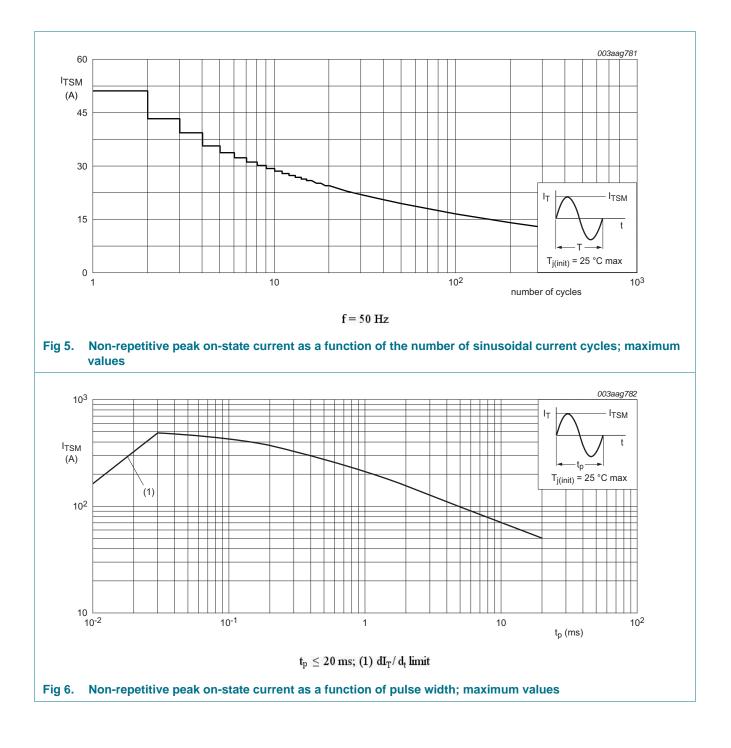
Fig 2. RMS on-state current as a function of surge duration; maximum values

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5. Thermal characteristics

Table 5.	mermai characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	half cycle; see Figure 7	-	-	2.4	K/W
		full cycle; see Figure 7	-	-	2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W

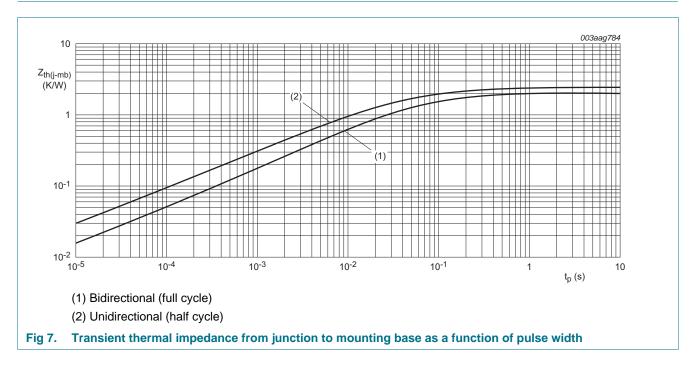


Table 5. Thermal characteristics

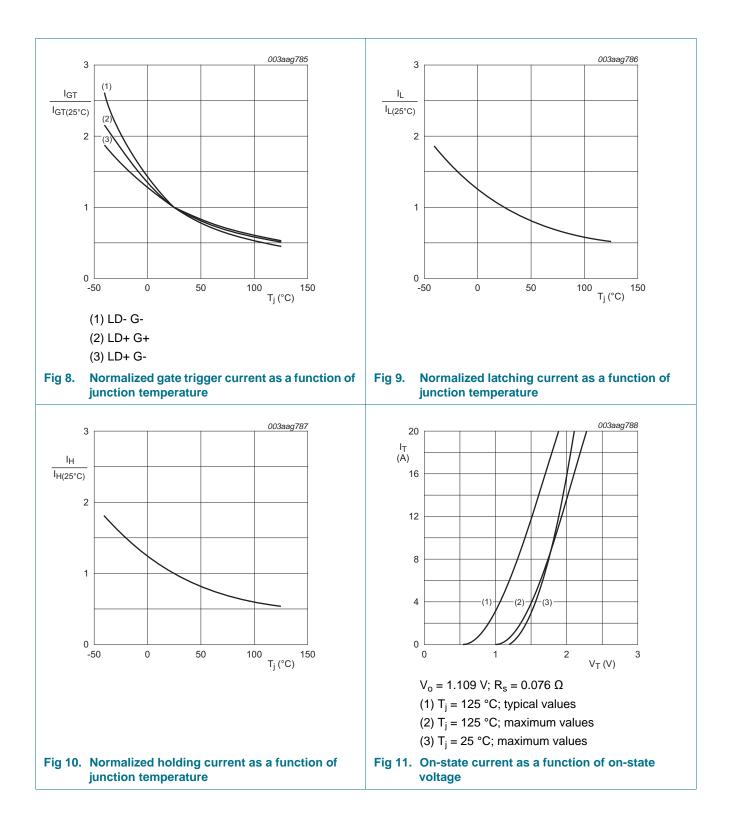
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6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ LD+ G+};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 8}}{100000000000000000000000000000000000$	-	-	10	mA
		V _D = 12 V; I _T = 100 mA; LD+ G-; T _j = 25 °C; see <u>Figure 8</u>	-	-	10	mA
		V _D = 12 V; I _T = 100 mA; LD- G-; T _j = 25 °C; see <u>Figure 8</u>	-	-	10	mA
IL	latching current	V _D = 12 V; I _G = 100 mA; LD+ G+; T _j = 25 °C; see <u>Figure 9</u>	-	-	30	mA
		$V_D = 12 \text{ V}; \text{ I}_G = 100 \text{ mA}; \text{ LD+ G-};$ $T_j = 25 \text{ °C}; \text{ see } Figure 9$	 	40	mA	
		$V_D = 12 \text{ V}; \text{ I}_G = 100 \text{ mA}; \text{ LD- G-};$ $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 9}}{2}$	-	-	30	mA
I _H	holding current	$V_D = 12 V; T_j = 25 °C;$ see Figure 10	-	-	25	mA
V _T	on-state voltage	I _T = 8 A; see <u>Figure 11</u>	-	-	1.7	V
V_{GT}	gate trigger voltage	V _D = 400 V; I _T = 100 mA; T _j = 125 °C; see <u>Figure 12</u>	0.2	-	-	V
		$V_D = 12 \text{ V}; \text{ I}_T = 100 \text{ mA}; \text{ T}_j = 25 \text{ °C};$ see Figure 12	-	-	1.5	V
D	off-state current	$V_D = 800 \text{ V}; \text{ T}_j = 25 \text{ °C}$	-	-	10	μA
		$V_D = 800 \text{ V}; \text{ T}_j = 125 \text{ °C}$	-	-	0.5	mA
dV _D /dt	rate of rise of off-state voltage	V _{DM} = 536 V; T _j = 125 °C; gate open circuit; exponential waveform; see <u>Figure 13</u>	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C};$ $I_{T(RMS)} = 6 \text{ A}; \text{ dV}_{com}/\text{dt} = 20 \text{ V/}\mu\text{s};$ (snubberless condition); gate open circuit; see Figure 14; see Figure 15	3.5	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C};$ $I_{T(RMS)} = 6 \text{ A}; \text{ dV}_{com}/\text{dt} = 10 \text{ V/}\mu\text{s};$ gate open circuit; see <u>Figure 14</u> ; see <u>Figure 15</u>	5	-	-	A/ms
		$\label{eq:VD} \begin{array}{l} V_D = 400 \; V; \; T_j = 125 \; ^{\circ}C; \\ I_{T(RMS)} = 6 \; A; \; dV_{com}/dt = 1 \; V/\mu s; \\ gate \; open \; circuit; \; see \; \underline{Figure \; 14}; \\ see \; \underline{Figure \; 15} \end{array}$	10	-	-	A/ms
√ _{CL}	clamping voltage	I _{CL} = 0.1 mA; t _p = 1 ms; T _i = 25 °C	850	-	-	V

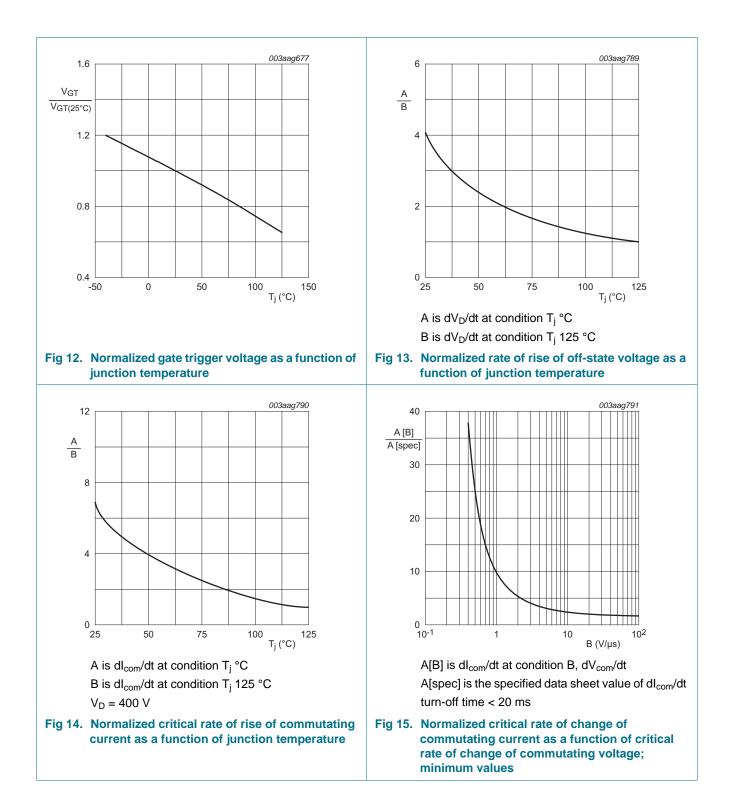
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7. Package outline

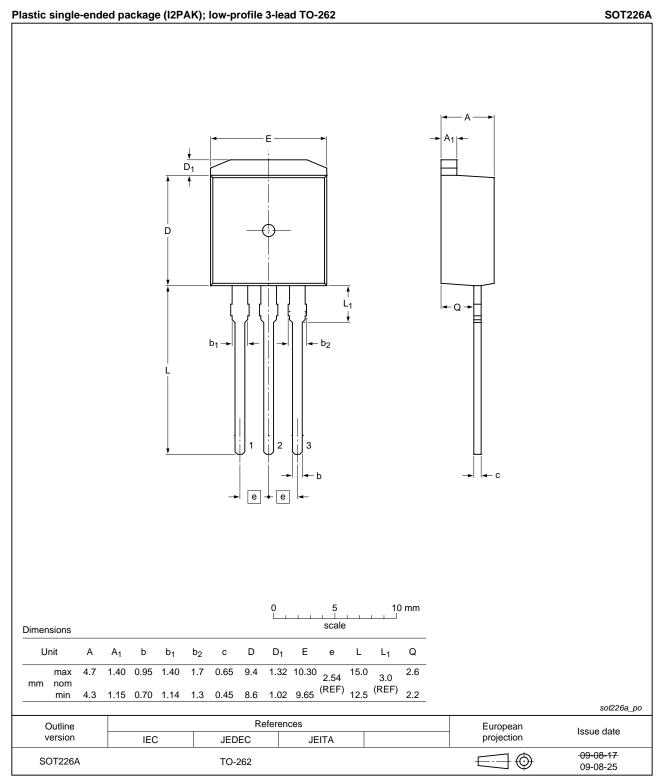


Fig 16. Package outline SOT226A (I2PAK)

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ACTT6G-800E



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8. Revision history

Table 7. Revision h	e 7. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
ACTT6G-800E v.1	20111101	Product data sheet	-	-		

9. Legal information

9.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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Date of release: 1 November 2011 Document identifier: ACTT6G-800E